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LC87F1HC4B

**CMOS LSI**

8-bit Microcontroller with USB-host Controller
128K-byte FROM / 12288-byte RAM / 48-pin

Overview

The LC87F1HC4B is an 8-bit microcomputer that, centered around a CPU running at a minimum bus cycle time of 83.3ns, integrates on a single chip a number of hardware features such as 128K-byte flash ROM (onboard programmable), 12288-byte RAM, an on-chip debugger, a sophisticated 16-bit timer/counter (may be divided into 8-bit timers), a 16-bit timer (may be divided into 8-bit timers or PWMs), four 8-bit timers with a prescaler, a base timer serving as a time-of-day clock, 3 channels of synchronous SIO interface with automatic data transfer capabilities, an asynchronous/synchronous SIO interface, a UART interface (full duplex), a full-speed USB interface (host control function), an 8-bit 12-channel AD converter, 2 channels of 12-bit PWM, a system clock frequency divider, an infrared remote control receiver circuit, and a 40-source 10-vector interrupt feature.
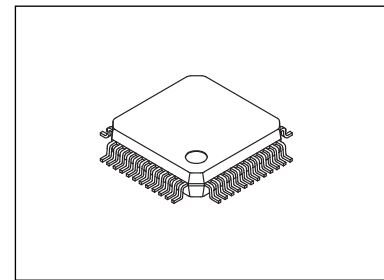
SPQFP48 7x7 / SQFP48

Features

■Flash ROM
- 131072 × 8 bits
- Capable of on-board programming with a wide range of supply voltages : 3.0 to 5.5V
- Block-erasable in 128 byte units
- Writes data in 2-byte units

■RAM
- 12288 × 9 bits

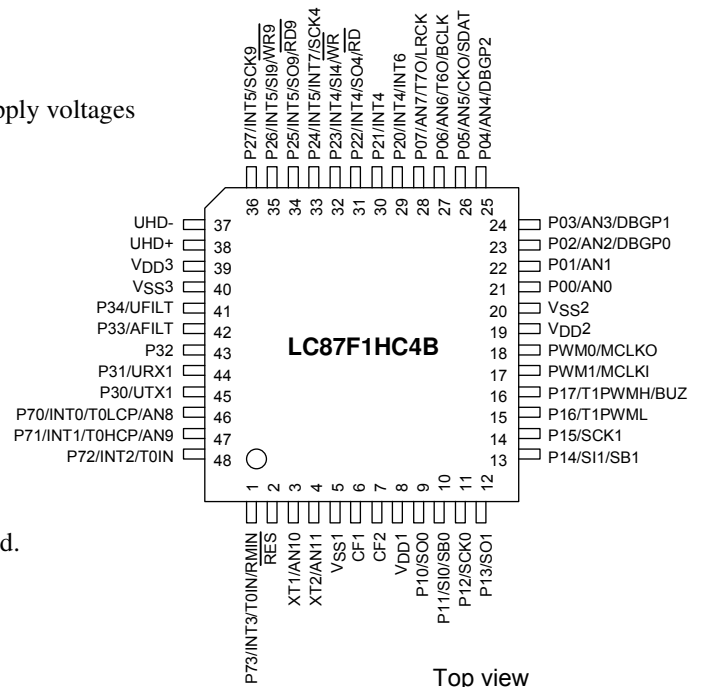■Package Form
- SQFP48 : Pb-Free type

■Bus Cycle Time
- 83.3ns (When CF=12MHz)
  Note : The bus cycle time here refers to the ROM read speed.

LC87F1HC4B

Top view

* This product is licensed from Silicon Storage Technology, Inc. (USA).

ORDERING INFORMATION

See detailed ordering and shipping information on page 28 of this data sheet.

■Minimum Instruction Cycle Time (tCYC)
- 250ns (When CF=12MHz)

■Ports
- I/O ports

  Ports whose I/O direction can be designated in 1-bit units 28 (P10 to P17, P20 to P27, P30 to P34,
  P70 to P73, PWM0, PWM1, XT2)

  Ports whose I/O direction can be designated in 4-bit units 8 (P00 to P07)
- USB ports   2 (UHD+, UHD-)
- Dedicated oscillator ports   2 (CF1, CF2)
- Input-only port (also used for oscillation)   1 (XT1)
- Reset pins   1 ($\overline{\text{RES}}$)
- Power supply pins   6 ($V_{SS}1$ to 3, $V_{DD}1$ to 3)

■Timers
- Timer 0: 16-bit timer/counter with 2 capture registers.

  Mode 0: 8-bit timer with an 8-bit programmable prescaler (with two 8-bit capture registers) × 2 channels

  Mode 1: 8-bit timer with an 8-bit programmable prescaler (with two 8-bit capture registers)
  + 8-bit counter (with two 8-bit capture registers)

  Mode 2: 16-bit timer with an 8-bit programmable prescaler (with two 16-bit capture registers)

  Mode 3: 16-bit counter (with two 16-bit capture registers)
- Timer 1: 16-bit timer/counter that supports PWM/toggle outputs

  Mode 0: 8-bit timer with an 8-bit prescaler (with toggle outputs) + 8-bit timer/
  counter with an 8-bit prescaler (with toggle outputs)

  Mode 1: 8-bit PWM with an 8-bit prescaler × 2 channels

  Mode 2: 16-bit timer/counter with an 8-bit prescaler (with toggle outputs)
  (toggle outputs also possible from lower-order 8 bits)

  Mode 3: 16-bit timer with an 8-bit prescaler (with toggle outputs)
  (lower-order 8 bits may be used as a PWM output)
- Timer 4: 8-bit timer with a 6-bit prescaler
- Timer 5: 8-bit timer with a 6-bit prescaler
- Timer 6: 8-bit timer with a 6-bit prescaler (with toggle outputs)
- Timer 7: 8-bit timer with a 6-bit prescaler (with toggle outputs)
- Base timer
  1) The clock is selectable from the subclock (32.768kHz crystal oscillation), system clock, and timer 0 prescaler output.
  2) Interrupts programmable in 5 different time schemes

■SIO
- SIO0: Synchronous serial interface
  1) LSB first/MSB first mode selectable
  2) Transfer clock cycle: 4/3 to 512/3 tCYC
  3) Automatic continuous data transmission (1 to 256 bits, specifiable in 1-bit units)
     (Suspension and resumption of data transmission possible in 1 byte units)
- SIO1: 8-bit asynchronous/synchronous serial interface

  Mode 0: Synchronous 8-bit serial I/O (2- or 3-wire configuration, 2 to 512 tCYC transfer clocks)

  Mode 1: Asynchronous serial I/O (half-duplex, 8 data bits, 1 stop bit, 8 to 2048 tCYC baudrates)

  Mode 2: Bus mode 1 (start bit, 8 data bits, 2 to 512 tCYC transfer clocks)

  Mode 3: Bus mode 2 (start detect, 8 data bits, stop detect)
- SIO4: Synchronous serial interface
  1) LSB first/MSB first mode selectable
  2) Transfer clock cycle: 4/3 to 1020/3 tCYC
  3) Automatic continuous data transmission (1 to 4096 bytes, specifiable in 1 byte units)
     (Suspension and resumption of data transmission possible in 1 byte units or in word units)
  4) Auto-start-on-falling-edge function
  5) Clock polarity selectable
  6) CRC16 calculator circuit built in

Continued from preceding page.

- SIO9: Synchronous serial interface
  1) LSB first/MSB first mode selectable
  2) Transfer clock cycle: 4/3 to 1020/3 tCYC
  3) Automatic continuous data transmission (1 to 4096 bytes, specifiable in 1 byte units)
     (Suspension and resumption of data transmission possible in 1 byte units or word units)
  4) Auto-start-on-falling-edge function
  5) Clock polarity selectable
  6) CRC16 calculator circuit built in

■Full Duplex UART
  1) Data length   : 7/8/9 bits selectable
  2) Stop bits   : 1 bit (2 bits in continuous transmission mode)
  3) Baud rate   : 16/3 to 8192/3 tCYC

■AD Converter: 8 bits × 12 channels

■PWM: Multifrequency 12-bit PWM × 2 channels

■Infrared Remote Control Receiver Circuit
  1) Noise rejection function (noise filter time constant: Approx. 120μs when the 32.768kHz crystal oscillator is
     selected as the base clock)
  2) Supports data encoding systems such as PPM (Pulse Position Modulation) and Manchester encoding.
  3) X'tal HOLD mode reset function

■USB Interface (host control function)
  1) Compliant with full-speed (12M bps) specifications
  2) Supports 4 transfer types (control transfer, bulk transfer, interrupt transfer, and isochronous transfer).

■Audio Interface
  1) Sampling frequency (fs)   : 32kHz, 44.1kHz, 48kHz
  2) Master clock frequency (internal PLL) : 12.288MHz, 16.9344MHz, 18.432MHz
  3) Bit clock selectable   : 48fs/64fs
  4) Data bit length   : 16/18/20/24 bits
  5) LSB first/MSB firsts selectable
  6) Left-justification/right-justification selectable

■Watchdog Timer
  - Watchdog timer using external RC circuitry
  - Interrupt and reset signals selectable

■Clock Output Function
  1) Can output a clock with a clock rate of 1/1, 1/2, 1/4, 1/8, 1/16, 1/32, or 1/64 of the source oscillator clock selected
     as the system clock.
  2) Can output the source oscillation clock for the subclock.

■Interrupts
- 40 sources, 10 vector addresses
  1) Provides three levels (low (L), high (H), and highest (X)) of multiplex interrupt control. Any interrupt requests of the level equal to or lower than the current interrupt are not accepted.
  2) When interrupt requests to two or more vector addresses occur at the same time, the interrupt of the highest level takes precedence over the other interrupts. For interrupts of the same level, the interrupt into the smallest vector address takes precedence.

No.	Vector Address	Level	Interrupt Source
1	00003H	X or L	INT0
2	0000BH	X or L	INT1
3	00013H	H or L	INT2/T0L/INT4/UHC bus active/remote control signal receive
4	0001BH	H or L	INT3/INT5/base timer
5	00023H	H or L	T0H/INT6/UHC device connected/UHC disconnected/UHC resume
6	0002BH	H or L	T1L/T1H/INT7/SIO9/AIF start
7	00033H	H or L	SIO0/UART1 receive
8	0003BH	H or L	SIO1/SIO4/UART1 transmit/end of AIF
9	00043H	H or L	ADC/T6/T7/UHC-ACK/UHC-NAK/UHC error/UHC STALL
10	0004BH	H or L	Port 0/PWM0/PWM1/T4/T5/UHC-SOF/DMCOPY

- Priority levels X > H > L
- Of interrupts of the same level, the one with the smallest vector address takes precedence.

■Subroutine Stack Levels: 6144 levels maximum (The stack is allocated in RAM.)

■High-speed Multiplication/Division Instructions
- 16 bits × 8 bits   (5 tCYC execution time)
- 24 bits × 16 bits   (12 tCYC execution time)
- 16 bits ÷ 8 bits   (8 tCYC execution time)
- 24 bits ÷ 16 bits   (12 tCYC execution time)

■Oscillation and PLL Circuits
- RC oscillation circuit (internal):   For system clock
- CF oscillation circuit: For system clock
- Crystal oscillation circuit: For system clock, time-of-day clock
- PLL circuit (internal):   For USB interface (see Fig.5)), audio interface (see Fig. 6)

■Standby Function
- HALT mode: Halts instruction execution while allowing the peripheral circuits to continue operation.
  1) Oscillation is not halted automatically.
  2) Canceled by a system reset or occurrence of an interrupt.
- HOLD mode: Suspends instruction execution and the operation of the peripheral circuits.
  1) The PLL base clock generator, CF, RC and crystal oscillators automatically stop operation.
  2) There are four ways of resetting the HOLD mode.
     (1) Setting the reset pin to the lower level.
     (2) Setting at least one of the INT0, INT1, INT2, INT4, and INT5 pins to the specified level
     (3) Having an interrupt source established at port 0
     (4) Having an bus active interrupt source established in the USB host controll circuit
- X'tal HOLD mode: Suspends instruction execution and the operation of the peripheral circuits except the base timer.
  1) The PLL base clock generator, CF and RC oscillator automatically stop operation.
  2) The state of crystal oscillation established when the X'tal HOLD mode is entered is retained.
  3) There are six ways of resetting the X'tal HOLD mode.
     (1) Setting the reset pin to the low level
     (2) Setting at least one of the INT0, INT1, INT2, INT4, and INT5 pins to the specified level
     (3) Having an interrupt source established at port 0
     (4) Having an interrupt source established in the base timer circuit
     (5) Having an bus active interrupt source established in the USB host controll circuit
     (6) Having an interrupt source established in the infrared remote controller receiver circuit

■Development Tools
 • On-chip debugger: TCB87- type-B + LC87F1HC4B

■Flash ROM Programming Boards

Package	Programming boards
SQFP48(7 × 7)	W87F55256SQ

■Recommended EPROM Programmer

Maker		Model	Supported version	Device
Flash Support Group, Inc. (FSG)	Single Programmer	AF9708/ AF9709/AF9709B/AF9709C (Including Ando Electric Co., Ltd. models)	Rev 02.82 or later	LC87F1HC8A
Flash Support Group, Inc. (FSG) + ON Semiconductor (Note 1)	Onboard Single/Gang Programmer	AF9101/AF9103(Main body) (FSG models)	(Note 2)	LC87F1HC8A
		SIB87(Inter Face Driver) (ON Semiconductor model)		
ON Semiconductor	Single/Gang Programmer	SKK/SKK TypeB (SanyoFWS)	Application Version 2.04 or later Chip Data Version 2.11 or later	LC87F1HC8
	Onboard Single/Gang Programmer	SKK-DBG TypeB (SanyoFWS)		

Note 1: With the FSG onboard programmer (AF9101/AF9103) and the serial interface driver (SIB87) provided by
    ON Semiconductor, PC-less standalone onboard programming is possible
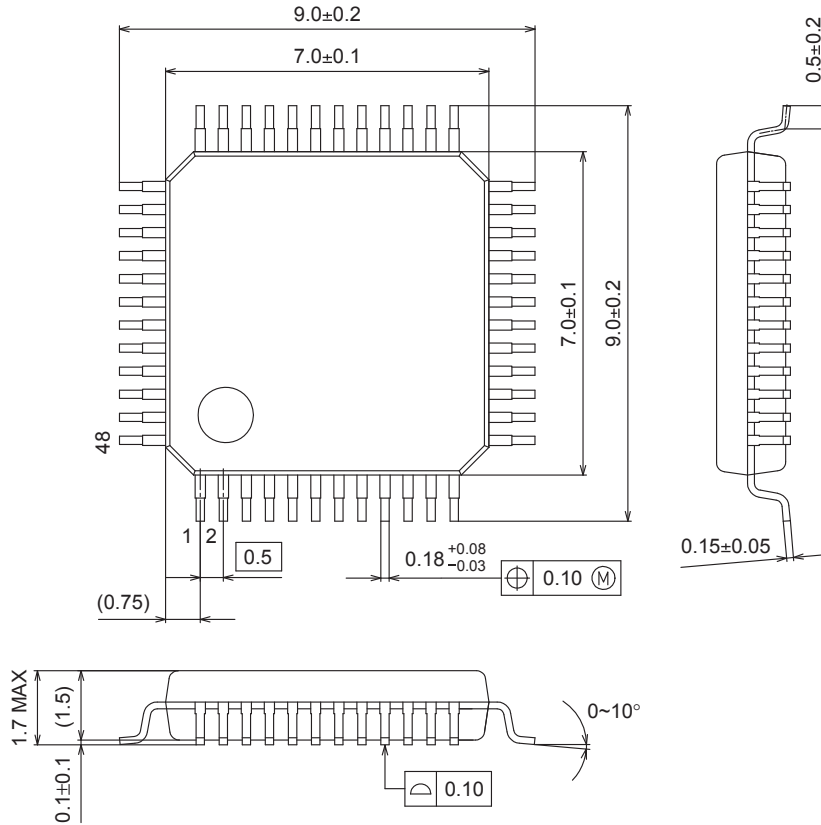Note 2: Depending on programming conditions, it is necessary to use a dedicated programming device and a program.
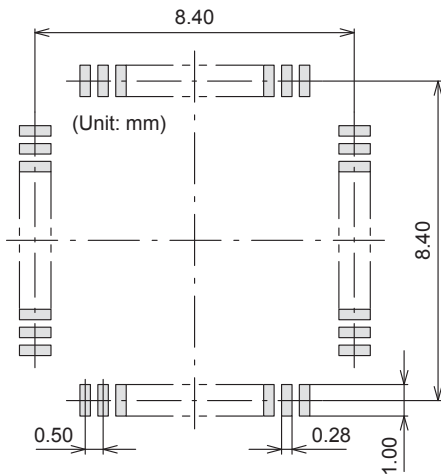   Please contact our company or FSG if you have any questions or difficulties regarding this matter.

Package Dimensions

unit : mm

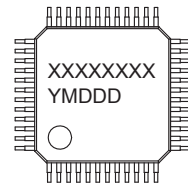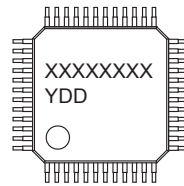**SPQFP48 7x7 / SQFP48**
CASE 131AJ
ISSUE A

9.0±0.2

7.0±0.1

0.5±0.2

7.0±0.1

9.0±0.2

48

1 2

0.5

(0.75)

0.18 $^{+0.08}_{-0.03}$

⊕ | 0.10 | Ⓜ

0.15±0.05

1.7 MAX

(1.5)

0.1±0.1

0~10°

▱ | 0.10

SOLDERING FOOTPRINT*

8.40

(Unit: mm)

8.40

0.50

0.28

1.00

**GENERIC
MARKING DIAGRAM***

XXXXXXXX
YDD

XXXXXXXX
YMDDD

XXXXX = Specific Device Code
Y = Year
DD = Additional Traceability Data

XXXXX = Specific Device Code
Y = Year
M = Month
DDD = Additional Traceability Data

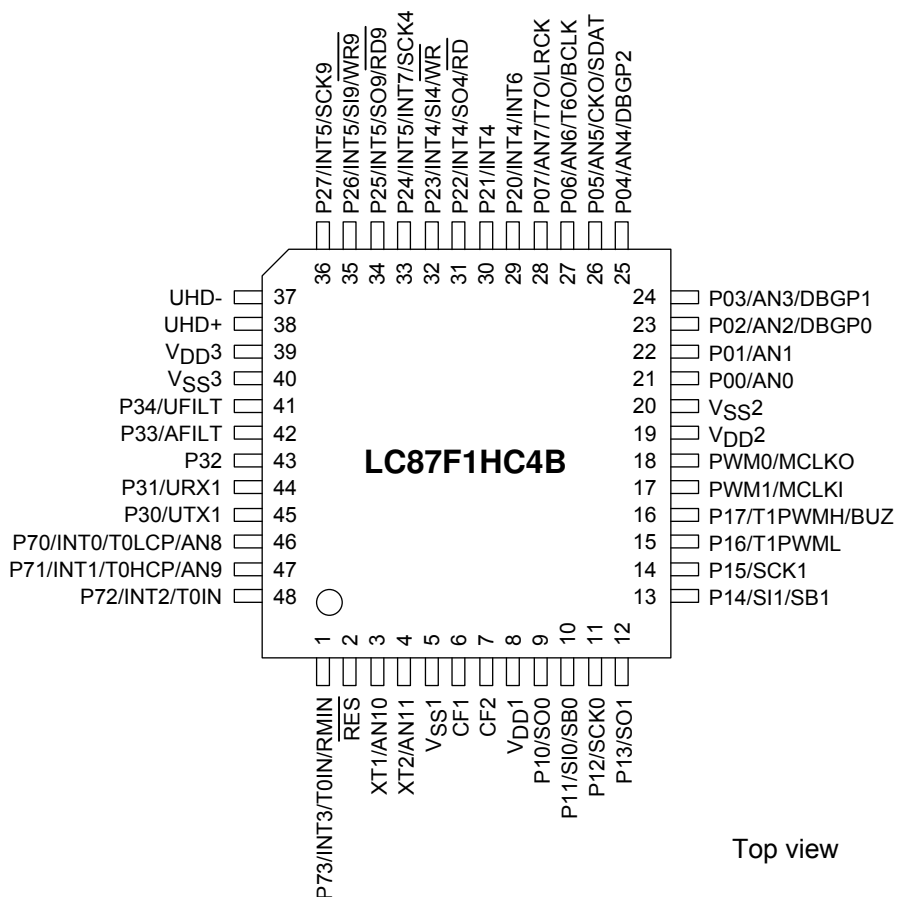*This information is generic. Please refer to
device data sheet for actual part marking.
Pb−Free indicator, "G" or microdot " ▪ ",
may or may not be present.

NOTE: The measurements are not to guarantee but for reference only.

*For additional information on our Pb−Free strategy and soldering
details, please download the ON Semiconductor Soldering and
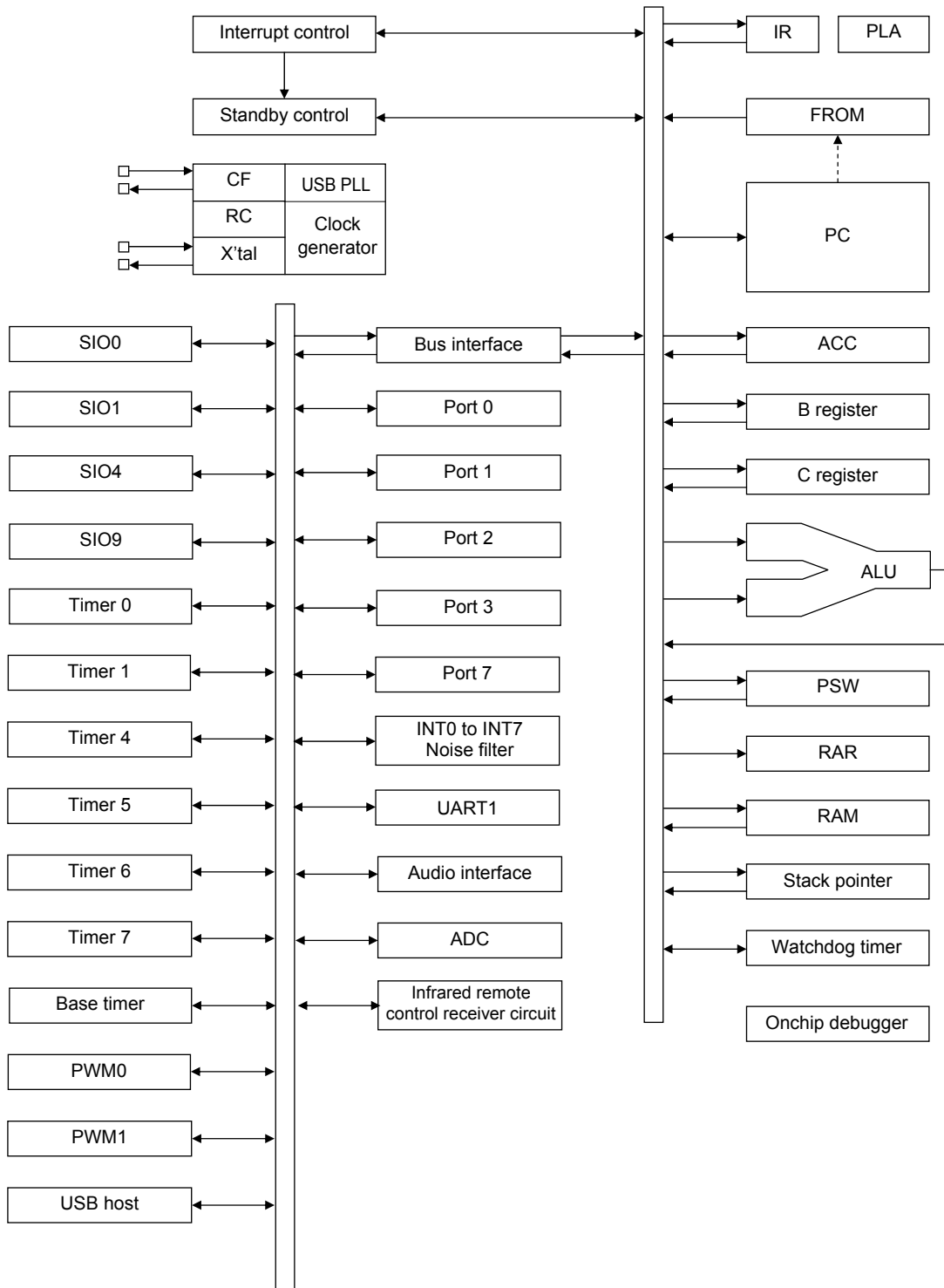Mounting Techniques Reference Manual, SOLDERRM/D.

Pin Assignment

Top view

SQFP48(7×7) : Pb-Free

SQFP48	NAME		SQFP48	NAME
1	P73/INT3/T0IN/RMIN		25	P04/AN4/DBGP2
2	$\overline{\text{RES}}$		26	P05/AN5/CKO/SDAT
3	XT1/AN10		27	P06/AN6/T6O/BCLK
4	XT2/AN11		28	P07/AN7/T7O/LRCK
5	$V_{SS}1$		29	P20/INT4/INT6
6	CF1		30	P21/INT4
7	CF2		31	P22/INT4/SO4/$\overline{\text{RD}}$
8	$V_{DD}1$		32	P23/INT4/SI4/$\overline{\text{WR}}$
9	P10/SO0		33	P24/INT5/INT7/SCK4
10	P11/SI0/SB0		34	P25/INT5/SO9/$\overline{\text{RD9}}$
11	P12/SCK0		35	P26/INT5/SI9/$\overline{\text{WR9}}$
12	P13/SO1		36	P27/INT5/SCK9
13	P14/SI1/SB1		37	UHD-
14	P15/SCK1		38	UHD+
15	P16/T1PWML		39	$V_{DD}3$
16	P17/T1PWMH/BUZ		40	$V_{SS}3$
17	PWM1/MCLKI		41	P34/UFILT
18	PWM0/MCLKO		42	P33/AFILT
19	$V_{DD}2$		43	P32
20	$V_{SS}2$		44	P31/URX1
21	P00/AN0		45	P30/UTX1
22	P01/AN1		46	P70/INT0/T0LCP/AN8
23	P02/AN2/DBGP0		47	P71/INT1/T0HCP/AN9
24	P03/AN3/DBGP1		48	P72/INT2/T0IN

System Block Diagram

Block	Connection
Interrupt control	
Standby control	
CF / USB PLL / RC / Clock generator / X'tal	
SIO0	
SIO1	
SIO4	
SIO9	
Timer 0	
Timer 1	
Timer 4	
Timer 5	
Timer 6	
Timer 7	
Base timer	
PWM0	
PWM1	
USB host	
Bus interface	
Port 0	
Port 1	
Port 2	
Port 3	
Port 7	
INT0 to INT7 Noise filter	
UART1	
Audio interface	
ADC	
Infrared remote control receiver circuit	
IR	PLA
FROM	
PC	
ACC	
B register	
C register	
ALU	
PSW	
RAR	
RAM	
Stack pointer	
Watchdog timer	
Onchip debugger	

Pin Description

Pin Name	I/O	Description	Option
$V_{SS}1$, $V_{SS}2$, $V_{SS}3$	-	- power supply	No
$V_{DD}1$, $V_{DD}2$	-	+ power supply	No
$V_{DD}3$	-	USB reference voltage	Yes
Port 0 P00 to P07	I/O	• 8-bit I/O ports • I/O specifiable in 4-bit units • Pull-up resistors can be turned on and off in 4-bit units. • HOLD reset input • Port 0 interrupt input • Pin functions 　AD converter input ports: AN0 to AN7(P00 to P07) 　Onchip debugger pins: DBGP0 to DBGP2(P02 to P04) 　P05: System clock output/audio interface SDAT input/output 　P06: Timer 6 toggle output/audio interface BCLK input/output 　P07: Timer 7 toggle output/audio interface LRCK input/output	Yes
Port 1 P10 to P17	I/O	• 8-bit I/O ports • I/O specifiable in 1-bit units • Pull-up resistors can be turned on and off in 1-bit units. • Pin functions 　P10: SIO0 data output　　　　　　　P14: SIO1 data input/bus input/output 　P11: SIO0 data input/bus input/output　P15: SIO1 clock input/output 　P12: SIO0 clock input/output　　　　P16: Timer 1 PWML output 　P13: SIO1 data output　　　　　　　P17: Timer 1 PWMH output/beeper output	Yes
Port 2 P20 to P27	I/O	• 8-bit I/O ports • I/O specifiable in 1-bit units • Pull-up resistors can be turned on and off in 1-bit units. • Pin functions 　P20 to P23: INT4 input/HOLD reset input/timer 1 event input/timer 0L capture input/ 　　　　　　timer 0H capture input 　P24 to P27: INT5 input/HOLD reset input/timer 1 event input/timer 0L capture input/ 　　　　　　timer 0H capture input 　P20: INT6 input/timer 0L capture 1 input 　P22: SIO4 data input/output/parallel interface $\overline{RD}$ output 　P23: SIO4 data input/output/parallel interface $\overline{WR}$ output 　P24: SIO4 clock input/output/INT7 input/timer 0H capture 1 input 　P25: SIO9 data input/output/parallel interface $\overline{RD9}$ output 　P26: SIO9 data input/output/parallel interface $\overline{WR9}$ output 　P27: SIO9 clock input/output Interrupt acknowledge types {{TABLE}}	Yes
Port 3 P30 to P34	I/O	• 5-bit I/O ports • I/O specifiable in 1-bit units • Pull-up resistors can be turned on and off in 1-bit units. • Pin functions 　P30: UART1 transmit 　P31: UART1 receive 　P33: Audio interface PLL filter pin (see Fig. 6.) 　P34: USB interface PLL filter pin (see Fig. 5.)	Yes

Interrupt acknowledge types (from Port 2 cell):

	Rising	Falling	Rising & Falling	H level	L level
INT4	enable	enable	enable	disable	disable
INT5	enable	enable	enable	disable	disable
INT6	enable	enable	enable	disable	disable
INT7	enable	enable	enable	disable	disable

Continued from preceding page.

Pin Name	I/O	Description	Option
Port 7 P70 to P73	I/O	• 4-bit I/O port • I/O specifiable in 1-bit units • Pull-up resistors can be turned on and off in 1-bit units. • Pin functions 　P70: INT0 input/HOLD reset input/timer 0L capture input/watchdog timer output 　P71: INT1 input/HOLD reset input/timer 0H capture input 　P72: INT2 input/HOLD reset input/timer 0 event input/timer 0L capture input/ 　　　high speed clock counter input 　P73: INT3 input (input with noise filter)/timer 0 event input/timer 0H capture input/ 　　　IR remote controller receiver input 　AD converter input ports: AN8(P70), AN9(P71) 　Interrupt acknowledge types	No

	Rising	Falling	Rising & Falling	H level	L level
INT0	enable	enable	disable	enable	enable
INT1	enable	enable	disable	enable	enable
INT2	enable	enable	enable	disable	disable
INT3	enable	enable	enable	disable	disable

Pin Name	I/O	Description	Option
PWM0 PWM1	I/O	PWM0, PWM1 output port General-purpose input port • Pin functions 　PWM0: Audio interface master clock output 　PWM1: Audio interface master clock input	No
UHD-	I/O	USB data I/O pin UHD-/general-purpose I/O port	No
UHD+	I/O	USB data I/O pin UHD+/general-purpose I/O port	No
$\overline{\text{RES}}$	Input	Reset pin	No
XT1	Input	• 32.768kHz crystal oscillator input • Pin functions 　General-purpose input port 　AD converter input ports: AN10 　Must be connected to $V_{DD}1$ when not to be used.	No
XT2	I/O	• 32.768kHz crystal oscillator output • Pin functions 　General-purpose I/O 　AD converter input port: AN11 　Must be set for oscillation and kept open if not to be used.	No
CF1	Input	Ceramic/crystal resonator input	No
CF2	Output	Ceramic/crystal resonator output	No

Port Output Types

The table below lists the types of port outputs and the presence/absence of a pull-up resistor.
Data can be read into any input port even if it is in the output mode.

Port Name	Option selected in units of	Option type	Output type	Pull-up resistor
P00 to P07	1 bit	1	CMOS	Programmable (Note 1)
		2	Nch-open drain	No
P10 to P17	1 bit	1	CMOS	Programmable
P20 to P27 P30 to P34		2	Nch-open drain	Programmable
P70	-	No	Nch-open drain	Programmable
P71 to P73	-	No	CMOS	Programmable
PWM0, PWM1	-	No	CMOS	No
UHD+, UHD-	-	No	CMOS	No
XT1	-	No	Input only	No
XT2	-	No	32.768kHz crystal resonator output (N channel open drain when in general-purpose output mode)	No

Note 1: Programmable pull-up resistors for port 0 are controlled in 4 bit units (P00 to 03, P04 to 07).

Power Pin Treatment

Connect the IC as shown below to minimize the noise input to the $V_{DD}1$ pin. and extend the backup period. Be sure to electrically short the $V_{SS}1$, $V_{SS}2$, and $V_{SS}3$ pins.

Example 1: When the microcontroller is in the backup state in the HOLD mode, the power to sustain the high level of output ports is supplied by their backup capacitors.
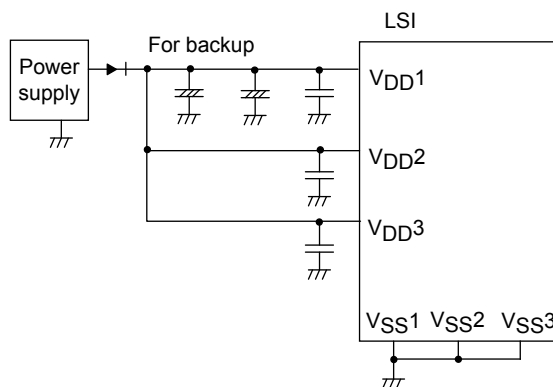
Example 2: The high level output at ports is not sustained and unstable in the HOLD backup mode.
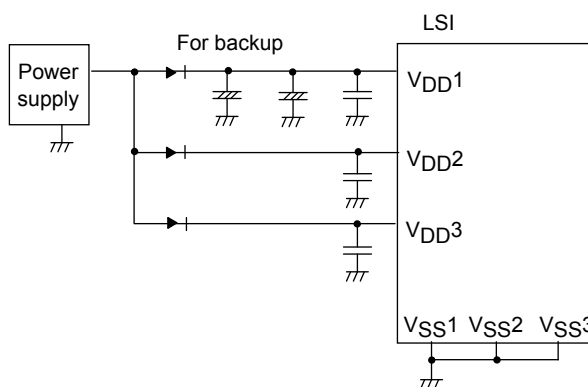
USB Reference Power Option

When a voltage 4.5 to 5.5V is supplied to $V_{DD}1$ and the internal USB reference voltage circuit is activated, the reference voltage for USB port output is generated. The active/inactive state of the reference voltage circuit can be switched by option select. The procedure for marking the option selection is described below.

		(1)	(2)	(3)	(4)
Option settings	USB regulator	USE	USE	USE	NONUSE
	USB regulator at HOLD mode	USE	NONUSE	NONUSE	NONUSE
	USB regulator at HALT mode	USE	NONUSE	USE	NONUSE
Reference voltage circuit state	Normal mode	active	active	active	inactive
	HOLD mode	active	inactive	inactive	inactive
	HALT mode	active	inactive	active	inactive

- When the USB reference voltage circuit is made inactive, the level of the reference voltage for USB port output is equal to $V_{DD}1$.
- Selection (2) or (3) can be used to set the reference voltage circuit inactive in HOLD or HALT mode.
- When the reference voltage circuit is activated, the current drain increases by approximately 100μA compared with when the reference voltage circuit is inactive.

Example 1: $V_{DD}1=V_{DD}2=3.3V$
- Inactivating the reference voltage circuit (selection (4)).
- Connecting $V_{DD}3$ to $V_{DD}1$ and $V_{DD}2$.
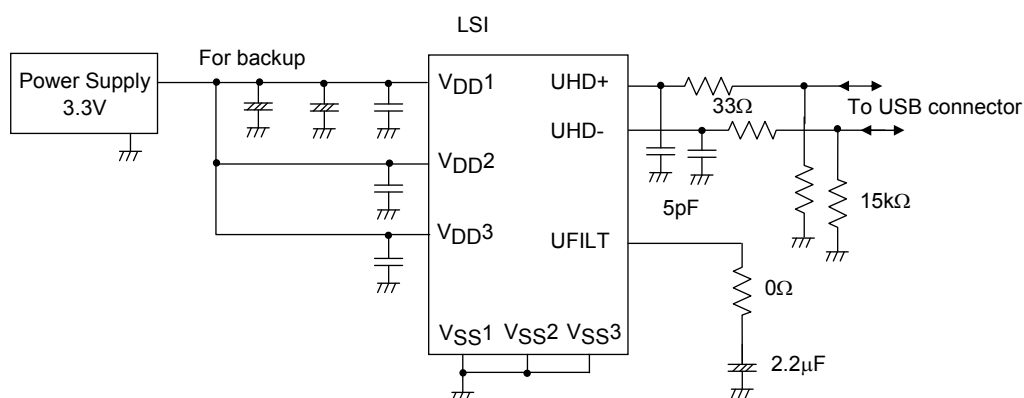
Example 2: $V_{DD}1=V_{DD}2=5.0V$
- Activating the reference voltage circuit (selection (1)).
- Isolating $V_{DD}3$ from $V_{DD}1$ and $V_{DD}2$, and connecting capacitor between $V_{DD}3$ and V_{SS}.
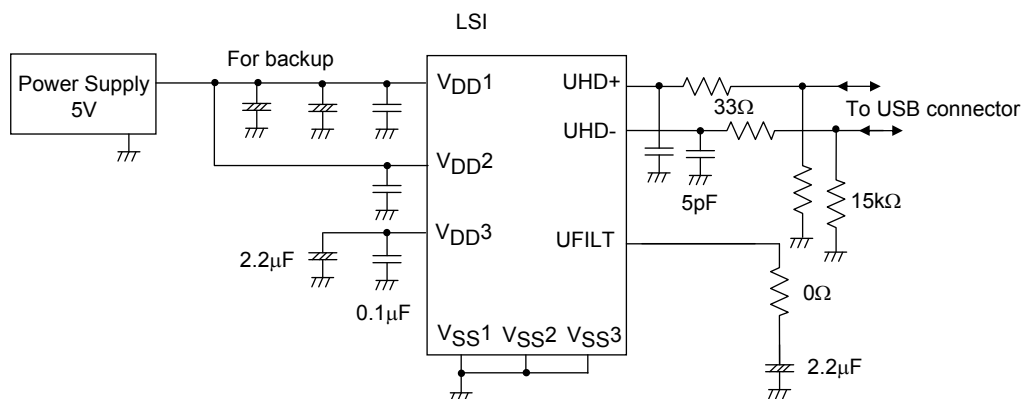
Absolute Maximum Ratings at Ta = 25°C, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Parameter		Symbol	Pin/Remarks	Conditions	Specification				unit
					V_{DD} [V]	min	typ	max	
Maximum supply voltage		V_{DD} max	$V_{DD}1$, $V_{DD}2$, $V_{DD}3$	$V_{DD}1= V_{DD}2= V_{DD}3$		−0.3		+6.5	V
Input voltage		$V_I(1)$	XT1, CF1			−0.3		V_{DD}+0.3	
Input/output voltage		$V_{IO}(1)$	Ports 0, 1, 2, 3, 7 PWM0, PWM1 XT2			−0.3		V_{DD}+0.3	
High level output current	Peak output current	IOPH(1)	Ports 0, 1, 2	• When CMOS output type is selected • Per 1 applicable pin		−10			mA
		IOPH(2)	PWM0, PWM1	Per 1 applicable pin		−20			
		IOPH(3)	Port 3 P71 to P73	• When CMOS output type is selected • Per 1 applicable pin		−5			
	Average output current (Note 1-1)	IOMH(1)	Ports 0, 1, 2	• When CMOS output type is selected • Per 1 applicable pin		−7.5			
		IOMH(2)	PWM0, PWM1	Per 1 applicable pin		−15			
		IOMH(3)	Port 3 P71 to P73	• When CMOS output type is selected • Per 1 applicable pin		−3			
	Total output current	ΣIOAH(1)	Ports 0, 2	Total current of all applicable pins		−25			
		ΣIOAH(2)	Port 1 PWM0, PWM1	Total current of all applicable pins		−25			
		ΣIOAH(3)	Ports 0, 1, 2 PWM0, PWM1	Total current of all applicable pins		−45			
		ΣIOAH(4)	Port 3 P71 to P73	Total current of all applicable pins		−10			
		ΣIOAH(5)	UHD+, UHD−	Total current of all applicable pins		−25			
Low level output current	Peak output current	IOPL(1)	P02 to P07 Ports 1, 2 PWM0, PWM1	Per 1 applicable pin				20	
		IOPL(2)	P00, P01	Per 1 applicable pin				30	
		IOPL(3)	Ports 3, 7 XT2	Per 1 applicable pin				10	
	Average output current (Note 1-1)	IOML(1)	P02 to P07 Ports 1, 2 PWM0, PWM1	Per 1 applicable pin				15	
		IOML(2)	P00, P01	Per 1 applicable pin				20	
		IOML(3)	Ports 3, 7 XT2	Per 1 applicable pin				7.5	
	Total output current	ΣIOAL(1)	Ports 0, 2	Total current of all applicable pins				45	
		ΣIOAL(2)	Port 1 PWM0, PWM1	Total current of all applicable pins				45	
		ΣIOAL(3)	Ports 0, 1, 2 PWM0, PWM1	Total current of all applicable pins				80	
		ΣIOAL(4)	Ports 3, 7 XT2	Total current of all applicable pins				15	
		ΣIOAL(5)	UHD+, UHD−	Total current of all applicable pins				25	
Allowable power Dissipation		Pd max	SQFP48(7×7)	Ta=−40 to +85°C				140	mW
Operating ambient Temperature		Topr				−40		+85	°C
Storage ambient temperature		Tstg				−55		+125	

Note 1-1: The average output current is an average of current values measured over 100 ms intervals.

Allowable Operating Conditions at Ta = −40°C to +85°C, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Parameter	Symbol	Pin/Remarks	Conditions	V_{DD} [V]	Specification min	typ	max	unit
Operating supply voltage (Note 2-1)	$V_{DD}(1)$	$V_{DD}1=V_{DD}2=V_{DD}3$	0.245µs ≤ tCYC ≤ 200µs		3.0		5.5	
			0.490µs ≤ tCYC ≤ 200µs Except in onboard programming mode		2.7		5.5	
Memory sustaining supply voltage	VHD	$V_{DD}1=V_{DD}2=V_{DD}3$	RAM and register contents sustained in HOLD mode.		2.0		5.5	
High level input voltage	$V_{IH}(1)$	Port 0, 1, 2, 3 P71 to P73 P70 port input/ interrupt side PWM0, PWM1		2.7 to 5.5	$0.3V_{DD}$ +0.7		V_{DD}	V
	$V_{IH}(2)$	Port 70 watchdog timer side		2.7 to 5.5	$0.9V_{DD}$		V_{DD}	
	$V_{IH}(3)$	XT1, XT2, CF1, $\overline{RES}$		2.7 to 5.5	$0.75V_{DD}$		V_{DD}	
Low level input voltage	$V_{IL}(1)$	Port 1, 2, 3 P71 to P73		4.0 to 5.5	V_{SS}		$0.1V_{DD}$ +0.4	
	$V_{IL}(2)$	P70 port input/ interrupt side		2.7 to 4.0	V_{SS}		$0.2V_{DD}$	
	$V_{IL}(3)$	Port 0 PWM0, PWM1		4.0 to 5.5	V_{SS}		$0.15V_{DD}$ +0.4	
	$V_{IL}(4)$			2.7 to 4.0	V_{SS}		$0.2V_{DD}$	
	$V_{IL}(5)$	Port 70 watchdog timer side		2.7 to 5.5	V_{SS}		$0.8V_{DD}$ -1.0	
	$V_{IL}(6)$	XT1, XT2, CF1, $\overline{RES}$		2.7 to 5.5	V_{SS}		$0.25V_{DD}$	
Instruction cycle time (Note 2-2)	tCYC			3.0 to 5.5	0.245		200	µs
			Except for onboard programming mode	2.7 to 5.5	0.490		200	
External system clock frequency	FEXCF(1)	CF1	• CF2 pin open • System clock frequency division ratio=1/1 • External system clock duty =50±5%	3.0 to 5.5	0.1		12	MHz
			• CF2 pin open • System clock frequency division ratio=1/1 • External system clock duty =50±5%	2.7 to 5.5	0.1		6	
Oscillation frequency range (Note 2-3)	FmCF(1)	CF1, CF2	When 12MHz ceramic oscillation See Fig. 1.	3.0 to 5.5		12		MHz
	FmCF(2)	CF1, CF2	When 6MHz ceramic oscillation See Fig. 1.	2.7 to 5.5		6		
	FmRC		Internal RC oscillation	2.7 to 5.5	0.3	1.0	2.0	
	FsX'tal	XT1, XT2	32.768kHz crystal oscillation See Fig. 2.	2.7 to 5.5		32.768		kHz

Note 2-1: V_{DD} must be held greater than or equal to 3.0V in the flash ROM onboard programming mode.

Note 2-2: Relationship between tCYC and oscillation frequency is 3/FmCF at a division ratio of 1/1 and 6/FmCF at a division ratio of 1/2.

Note 2-3: See Tables 1 and 2 for the oscillation constants.

Electrical Characteristics at Ta = −40°C to +85°C, $V_{SS1} = V_{SS2} = V_{SS3} = 0V$

Parameter	Symbol	Pin/Remarks	Conditions	V_{DD} [V]	min	typ	max	unit
High level input current	$I_{IH}(1)$	Ports 0, 1, 2, 3 Port 7 $\overline{RES}$ PWM0, PWM1 UHD+, UHD-	Output disabled Pull-up resistor off $V_{IN}=V_{DD}$ (Including output Tr's off leakage current)	2.7 to 5.5			1	μA
	$I_{IH}(2)$	XT1, XT2	Input port configuration $V_{IN}=V_{DD}$	2.7 to 5.5			1	
	$I_{IH}(3)$	CF1	$V_{IN}=V_{DD}$	2.7 to 5.5			15	
Low level input current	$I_{IL}(1)$	Ports 0, 1, 2, 3 Port 7 $\overline{RES}$ PWM0, PWM1 UHD+, UHD−	Output disabled Pull-up resistor off $V_{IN}=V_{SS}$ (Including output Tr's off leakage current)	2.7 to 5.5	−1			
	$I_{IL}(2)$	XT1, XT2	Input port configuration $V_{IN}=V_{SS}$	2.7 to 5.5	−1			
	$I_{IL}(3)$	CF1	$V_{IN}=V_{SS}$	2.7 to 5.5	−15			
High level output voltage	$V_{OH}(1)$	Ports 0, 1, 2, 3 P71 to P73	$I_{OH}=−1mA$	4.5 to 5.5	$V_{DD}−1$			
	$V_{OH}(2)$		$I_{OH}=−0.4mA$	3.0 to 5.5	$V_{DD}−0.4$			
	$V_{OH}(3)$		$I_{OH}=−0.2mA$	2.7 to 5.5	$V_{DD}−0.4$			
	$V_{OH}(4)$	PWM0, WM1	$I_{OH}=−10mA$	4.5 to 5.5	$V_{DD}−1.5$			
	$V_{OH}(5)$	P05 to P07	$I_{OH}=−1.6mA$	3.0 to 5.5	$V_{DD}−0.4$			
	$V_{OH}(6)$	(Note 3-1)	$I_{OH}=−1mA$	2.7 to 5.5	$V_{DD}−0.4$			
Low level output voltage	$V_{OL}(1)$	P00, P01	$I_{OL}=30mA$	4.5 to 5.5			1.5	V
	$V_{OL}(2)$		$I_{OL}=5mA$	3.0 to 5.5			0.4	
	$V_{OL}(3)$		$I_{OL}=2.5mA$	2.7 to 5.5			0.4	
	$V_{OL}(4)$	Ports 0, 1, 2 PWM0, PWM1 XT2	$I_{OL}=10mA$	4.5 to 5.5			1.5	
	$V_{OL}(5)$		$I_{OL}=1.6mA$	3.0 to 5.5			0.4	
	$V_{OL}(6)$		$I_{OL}=1mA$	2.7 to 5.5			0.4	
	$V_{OL}(7)$	Ports 3, 7	$I_{OL}=1.6mA$	3.0 to 5.5			0.4	
	$V_{OL}(8)$		$I_{OL}=1mA$	2.7 to 5.5			0.4	
Pull-up resistance	$R_{pu}(1)$	Ports 0, 1, 2, 3 Port 7	$V_{OH}=0.9V_{DD}$	4.5 to 5.5	15	35	80	kΩ
	$R_{pu}(2)$			2.7 to 5.5	18	50	150	
Hysteresis voltage	VHYS	$\overline{RES}$ Port 1, 2, 3, 7		2.7 to 5.5		$0.1V_{DD}$		V
Pin capacitance	CP	All pins	For pins other than that under test: $V_{IN}=V_{SS}$ f=1MHz Ta=25°C	2.7 to 5.5		10		pF

Note 3-1: When the CKO system clock output function (P05) or audio interface output function (P05 to P07)is used.

Serial I/O Characteristics at Ta = –40°C to +85°C, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

1. SIO0 Serial I/O Characteristics (Note 4-1-1)

Parameter		Symbol	Pin/ Remarks	Conditions	Specification				
					V_{DD} [V]	min	typ	max	unit
Serial clock	Input clock	Frequency	tSCK(1)	SCK0(P12)	See Fig. 8.	2.7 to 5.5	2			tCYC
		Low level pulse width	tSCKL(1)				1			
		High level pulse width	tSCKH(1)				1			
			tSCKHA(1a)		• Continuous data transfer mode • USB, AIF, SIO4, SIO9, and DMCOPY not used at the same time. • See Fig. 8. • (Note 4-1-2)		4			
			tSCKHA(1b)		• Continuous data transfer mode • USB used at the same time. • AIF, SIO4, SIO9, and DMCOPY not used at the same time. • See Fig. 8. • (Note 4-1-2)		7			
			tSCKHA(1c)		• Continuous data transfer mode • USB, AIF, SIO4, SIO9, and DMCOPY used at the same time. • See Fig. 8. • (Note 4-1-2)		9			
	Output clock	Frequency	tSCK(2)	SCK0(P12)	• When CMOS output type is selected • See Fig. 8.	2.7 to 5.5	4/3			tSCK
		Low level pulse width	tSCKL(2)					1/2		
		High level pulse width	tSCKH(2)					1/2		
			tSCKHA(2a)		• Continuous data transfer mode • USB, AIF, SIO4, SIO9, and DMCOPY not used at the same time. • When CMOS output type is selected • See Fig. 8.		tSCKH(2) +2tCYC		tSCKH(2) + (10/3)tCYC	tCYC
			tSCKHA(2b)		• Continuous data transfer mode • USB used at the same time. • AIF, SIO4, SIO9, and DMCOPY not used at the same time. • When CMOS output type is selected. • See Fig. 8.		tSCKH(2) +2tCYC		tSCKH(2) + (19/3)tCYC	
			tSCKHA(2c)		• Continuous data transfer mode • USB, AIF, SIO4, SIO9, and DMCOPY used at the same time • When CMOS output type is selected • See Fig. 8.		tSCKH(2) +2tCYC		tSCKH(2) + (25/3)tCYC	

Note 4-1-1: These specifications are theoretical values. Margins must be allowed according to the actual operating conditions.

Note 4-1-2: In an application where the serial clock input is to be used in the continuous data transfer mode, the time from SI0RUN being set when serial clock is high to the falling edge of the first serial clock must be longer than tSCKHA.

Continued from preceding page.

Parameter			Symbol	Pin/ Remarks	Conditions	Specification				
						V_DD [V]	min	typ	max	unit
Serial input		Data setup time	tsDI(1)	SB0(P11), SI0(P11)	• Must be specified with respect to rising edge of SIOCLK. • See Fig. 8.	2.7 to 5.5	0.03			μs
		Data hold time	thDI(1)				0.03			
Serial output	Input clock	Output delay time	tdD0(1)	SO0(P10), SB0(P11)	• Continuous data transfer mode • (Note 4-1-3)	2.7 to 5.5			(1/3)tCYC +0.05	μs
			tdD0(2)		• Synchronous 8-bit mode • (Note 4-1-3)				1tCYC +0.05	
	Output clock		tdD0(3)		(Note 4-1-3)				(1/3)tCYC +0.05	

Note 4-1-3: Must be specified with respect to falling edge of SIOCLK.
Must be specified as the time to the beginning of output state change in open drain output mode. See Fig. 8.

2. SIO1 Serial I/O Characteristics (Note 4-2-1)

Parameter			Symbol	Pin/ Remarks	Conditions	Specification				
						V_DD [V]	min	typ	max	unit
Serial clock	Input clock	Frequency	tSCK(3)	SCK1(P15)	See Fig. 8.	2.7 to 5.5	2			tCYC
		Low level pulse width	tSCKL(3)				1			
		High level pulse width	tSCKH(3)				1			
	Output clock	Frequency	tSCK(4)	SCK1(P15)	• When CMOS output type is selected • See Fig. 8.	2.7 to 5.5	2			tCYC
		Low level pulse width	tSCKL(4)					1/2		tSCK
		High level pulse width	tSCKH(4)					1/2		
Serial input		Data setup time	tsDI(2)	SB1(P14), SI1(P14)	• Must be specified with respect to rising edge of SIOCLK. • See Fig. 8.	2.7 to 5.5	0.03			
		Data hold time	thDI(2)				0.03			
Serial output		Output delay time	tdD0(4)	SO1(P13), SB1(P14)	• Must be specified with respect to falling edge of SIOCLK. • Must be specified as the time to the beginning of output state change in open drain output mode. • See Fig. 8.	2.7 to 5.5			(1/3)tCYC +0.05	μs

Note 4-2-1: These specifications are theoretical values. Margins must be allowed according to the actual operating conditions.

3. SIO4 Serial I/O Characteristics (Note 4-3-1)

Parameter			Symbol	Pin/Remarks	Conditions	V$_{DD}$ [V]	min	typ	max	unit
Serial clock	Input clock	Frequency	tSCK(5)	SCK4(P24)	See Fig. 8.	2.7 to 5.5	2			tCYC
		Low level pulse width	tSCKL(5)				1			
		High level pulse width	tSCKH(5)				1			
			tSCKHA(5a)		• USB, SIO0 continuous transfer mode, AIF, SIO9, and DMCOPY not used at the same time. • See Fig. 8. • (Note 4-3-2)		4			
			tSCKHA(5b)		• USB used at the same time • SIO0 continuous transfer mode, AIF, SIO9, DMCOPY not used at the same time. • See Fig. 8. • (Note 4-3-2)		7			
			tSCKHA(5c)		• USB, SIO0 continuous transfer mode, SIO9, and DMCOPY used at the same time. • AIF not used at the same time. • See Fig. 8. • (Note 4-3-2)		12			
	Output clock	Frequency	tSCK(6)	SCK4(P24)	• When CMOS output type is selected. • See Fig. 8.	2.7 to 5.5	4/3			tSCK
		Low level pulse width	tSCKL(6)					1/2		
		High level pulse width (Note 4-3-3)	tSCKH(6)					1/2		
			tSCKHA(6a)		• USB, SIO0 continuous transfer mode, AIF, SIO9, and DMCOPY not used at the same time. • When CMOS output type is selected. • See Fig. 8.		tSCKH(6) + (5/3)tCYC		tSCKH(6) + (10/3)tCYC	tCYC
			tSCKHA(6b)		• USB used at the same time. • SIO0 continuous transfer mode, AIF, SIO9, and DMCOPY not used at the same time. • When CMOS output type is selected. • See Fig. 8.		tSCKH(6) + (5/3)tCYC		tSCKH(6) + (19/3)tCYC	
			tSCKHA(6c)		• USB, SIO0 continuous transfer mode, SIO9, and DMCOPY used at the same time. • AIF not used at the same time. • When CMOS output type is selected. • See Fig. 8.		tSCKH(6) + (5/3)tCYC		tSCKH(6) + (34/3)tCYC	

Note 4-3-1: These specifications are theoretical values. Margins must be allowed according to the actual operating conditions.

Note 4-3-2: In an application where the serial clock input is to be used in the continuous data transfer mode, the period from the time SI4RUN is set with the serial clock set high to the falling edge of the first serial clock must be longer than tSCKHA.

Note 4-3-3: When using the serial clock output, make sure that the load at the SCK4 (P24) pin meets the following conditions:
Clock rise time tSCKR < 0.037μs (see Figure 12.) at Ta=+25°C, V$_{DD}$=3.3V

Continued from preceding page.

Parameter		Symbol	Pin/ Remarks	Conditions	Specification				
					V_{DD} [V]	min	typ	max	unit
Serial input	Data setup time	tsDI(3)	SO4(P22), SI4(P23)	• Must be specified with respect to falling edge of SIOCLK. • See Fig. 8	2.7 to 5.5	0.03			μs
	Data hold time	thDI(3)				0.03			
Serial output	Output delay time	tdD0(5)	SO4(P22), SI4(P23)	• Must be specified with respect to rising edge of SIOCLK. • Must be specified as the time to the beginning of output state change in open drain output mode. • See Fig. 8.	2.7 to 5.5			(1/3)tCYC +0.05	

4. SIO9 Serial I/O Characteristics (Note 4-4-1)

Parameter			Symbol	Pin/ Remarks	Conditions	Specification				
						V_{DD} [V]	min	typ	max	unit
Serial clock	Input clock	Frequency	tSCK(7)	SCK9(P27)	See Fig. 8.	2.7 to 5.5	2			tCYC
		Low level pulse width	tSCKL(7)				1			
		High level pulse width	tSCKH(7)				1			
			tSCKHA(7a)		• USB, SIO0 continuous transfer mode, AIF, SIO4 and DMCOPY not used at the same time. • See Fig. 8. • (Note 4-4-2)		4			
			tSCKHA(7b)		• USB used at the same time. • SIO0 continuous transfer mode, AIF, SIO4, and DMCOPY not used at the same time. • See Fig. 8. • (Note 4-4-2)		7			
			tSCKHA(7c)		• USB, SIO0 continuous transfer mode, SIO4 and DMCOPY used at the same time. • AIF not used at the same time. • See Fig. 8. • (Note 4-4-2)		15			

Note 4-4-1: These specifications are theoretical values. Margins must be allowed according to the actual operating conditions.

Note 4-4-2: In an application where the serial clock input is to be used in the continuous data transfer mode, the period from the time SI9RUN is set with the serial clock set high to the falling edge of the first serial clock must be longer than tSCKHA.

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Parameter			Symbol	Pin/ Remarks	Conditions	Specification				
						V$_{DD}$ [V]	min	typ	max	unit
Serial clock	Output clock	Frequency	tSCK(8)	SCK9(P27)	• When CMOS output type is selected. • See Fig. 8.	2.7 to 5.5	4/3			tCYC
		Low level pulse width	tSCKL(8)					1/2		tSCK
		High level pulse width (Note 4-4-3)	tSCKH(8)					1/2		
			tSCKHA(8a)		• USB, SIO0 continuous transfer mode, AIF SIO4 DMCOPY not used at the same time. • When CMOS output type is selected. • See Fig. 8.		tSCKH(8) + (5/3)tCYC		tSCKH(8) + (10/3)tCYC	tCYC
			tSCKHA(8b)		• USB used at the same time. • SIO0 continuous transfer mode, AIF, SIO4, and DMCOPY not used at the same time. • When CMOS output type is selected • See Fig. 8.		tSCKH(8) + (5/3)tCYC		tSCKH(8) + (19/3)tCYC	
			tSCKHA(8c)		• USB, SIO0 continuous transfer mode , SIO4, and DMCOPY used at the same time. • AIF not used at the same time. • When CMOS output type is selected. • See Fig. 8.		tSCKH(8) + (5/3)tCYC		tSCKH(8) + (43/3)tCYC	
Serial input		Data setup time	tsDI(4)	SO9(P25), SI9(P26)	• Must be specified with respect to rising edge of SIOCLK. • See Fig. 8.	2.7 to 5.5	0.03			
		Data hold time	thDI(4)				0.03			
Serial output		Output delay time	tdDO(6)	SO9(P25), SI9(P26)	• Must be specified with respect to falling edge of SIOCLK. • Must be specified as the time to the beginning of output state change in open drain output mode • See Fig. 8.	2.7 to 5.5			(1/3)tCYC +0.05	µs

Note 4-4-3: When using the serial clock output, make sure that the load at the SCK9 (P27) pin meets the following conditions:
Clock rise time tSCKR < 0.037µs (see Figure 12.) at Ta=+25°C, V$_{DD}$=3.3V

Pulse Input Conditions at Ta = –40°C to +85°C, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Parameter	Symbol	Pin/Remarks	Conditions	Specification				
				V_{DD} [V]	min	typ	max	unit
High/low level pulse width	tP1H(1) tP1L(1)	INT0(P70), INT1(P71), INT2(P72), INT4(P20 to P23), INT5(P24 to P27), INT6(P20), INT7(P24)	• Interrupt source flag can be set. • Event inputs for timer 0 or 1 are enabled.	2.7 to 5.5	1			tCYC
	tPIH(2) tPIL(2)	INT3(P73) when noise filter time constant is 1/1	• Interrupt source flag can be set. • Event inputs for timer 0 are enabled.	2.7 to 5.5	2			
	tPIH(3) tPIL(3)	INT3(P73) when noise filter time constant is 1/32	• Interrupt source flag can be set. • Event inputs for timer 0 are nabled.	2.7 to 5.5	64			
	tPIH(4) tPIL(4)	INT3(P73) when noise filter time constant is 1/128	• Interrupt source flag can be set. • Event inputs for timer 0 are enabled.	2.7 to 5.5	256			
	tPIL(5)	RMIN(P73)	Recognized by the infrared remote control receiver circuit as a signal	2.7 to 5.5	4			RMCK (Note 5-1)
	tPIL(6)	$\overline{RES}$	Resetting is enabled.	2.7 to 5.5	200			μs

Note 5-1: Represents the period of the reference clock (1 tCYC to 128 tCYC or the source frequency of the subclock) for the infrared remote control receiver circuit.

AD Converter Characteristics at Ta = –40°C to +85°C, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Parameter	Symbol	Pin/Remarks	Conditions	Specification				
				V_{DD} [V]	min	typ	max	unit
Resolution	N	AN0(P00) to AN7(P07), AN8(P70), AN9(P71), AN10(XT1), AN11(XT2)		3.0 to 5.5		8		bit
Absolute accuracy	ET		(Note 6-1)	3.0 to 5.5			±1.5	LSB
Conversion time	TCAD		AD conversion time=32×tCYC (when ADCR2=0) (Note 6-2)	4.5 to 5.5	15.68 (tCYC= 0.490μs)		97.92 (tCYC= 3.06μs)	μs
				3.0 to 5.5	23.52 (tCYC= 0.735μs)		97.92 (tCYC= 3.06μs)	
			AD conversion time=64×tCYC (when ADCR2=1) (Note 6-2)	4.5 to 5.5	18.82 (tCYC= 0. 294μs)		97.92 (tCYC= 1.53μs)	
				3.0 to 5.5	47.04 (tCYC= 0.735μs)		97.92 (tCYC= 1.53μs)	
Analog input voltage range	VAIN			3.0 to 5.5	V_{SS}		V_{DD}	V
Analog port input current	IAINH		VAIN=V_{DD}	3.0 to 5.5			1	μA
	IAINL		VAIN=V_{SS}	3.0 to 5.5	−1			

Note 6-1: The quantization error (±1/2LSB) is excluded from the absolute accuracy.

Note 6-2: The conversion time refers to the period from the time when an instruction for starting a conversion process is issued to the time the conversion results register(s) are loaded with a complete digital conversion value corresponding to the analog input value.

Consumption Current Characteristics at Ta = –40°C to +85°C, $V_{SS}1 = V_{SS}2 = V_{SS}3 = 0V$

Parameter	Symbol	Pin/ Remarks	Conditions	V_{DD} [V]	min	typ	max	unit
Normal mode consumption current (Note 7-1)	IDDOP(1)	$V_{DD}1$ $=V_{DD}2$ $=V_{DD}3$	• FmCF=12MHz ceramic oscillation mode • FsX'tal=32.768kHz crystal oscillation mode • System clock set to 12MHz side • Internal PLL oscillation stopped • Internal RC oscillation stopped • USB circuit stopped • 1/1 frequency division ratio	4.5 to 5.5		9.8	24	mA
	IDDOP(2)			3.0 to 3.6		5.7	14	
	IDDOP(3)		• FmCF=12MHz ceramic oscillation mode • FsX'tal=32.768kHz crystal oscillation mode • System clock set to 12MHz side • Internal PLL oscillation mode active • Internal RC oscillation stopped • USB circuit active • 1/1 frequency division ratio	4.5 to 5.5		15	35	
	IDDOP(4)			3.0 to 3.6		7.7	20	
	IDDOP(5)		• FmCF=12MHz ceramic oscillation mode • FsX'tal=32.768kHz crystal oscillation mode • System clock set to 6MHz side • Internal RC oscillation stopped • 1/2 frequency division ratio	4.5 to 5.5		6.7	16	
	IDDOP(6)			3.0 to 3.6		3.9	9.0	
	IDDOP(7)			2.7 to 3.0		3.2	7.3	
	IDDOP(8)		• FmCF=0Hz(oscillation stopped) • FsX'tal=32.768kHz crystal oscillation mode • System clock set to internal RC oscillation. • 1/2 frequency division ratio	4.5 to 5.5		0.72	3.4	
	IDDOP(9)			3.0 to 3.6		0.41	1.9	
	IDDOP(10)			2.7 to 3.0		0.35	1.5	
	IDDOP(11)		• FmCF=0Hz(oscillation stopped) • FsX'tal=32.768kHz crystal oscillation mode • System clock set to crystal oscillation. (32.768kHz) • Internal RC oscillation stopped • 1/2 frequency division ratio	4.5 to 5.5		45	184	μA
	IDDOP(12)			3.0 to 3.6		18	65	
	IDDOP(13)			2.7 to 3.0		14	47	
HALT mode consumption current (Note7-1)	IDDHALT(1)		• HALT mode • FmCF=12MHz ceramic oscillation mode • FsX'tal=32.768kHz crystal oscillation mode • System clock set to 12MHz side • Internal PLL oscillation stopped • Internal RC oscillation stopped • USB circuit stopped • 1/1 frequency division ratio	4.5 to 5.5		4.9	12	
	IDDHALT(2)			3.0 to 3.6		2.7	6.4	
	IDDHALT(3)		• HALT mode • FmCF=12MHz ceramic oscillation mode • FsX'tal=32.768kHz crystal oscillation mode • System clock set to 12MHz side • Internal PLL oscillation mode active • Internal RC oscillation stopped • USB circuit active • 1/1 frequency division ratio	4.5 to 5.5		9.5	23	
	IDDHALT(4)			3.0 to 3.6		4.7	12	mA
	IDDHALT(5)		• HALT mode • FmCF=12MHz ceramic oscillation mode • FsX'tal=32.768kHz crystal oscillation mode • System clock set to 6MHz side • Internal RC oscillation stopped • 1/2 frequency division ratio	4.5 to 5.5		3.0	7.3	
	IDDHALT(6)			3.0 to 3.6		1.6	3.8	
	IDDHALT(7)			2.7 to 3.0		1.3	2.9	
	IDDHALT(8)		• HALT mode • FmCF=0Hz(oscillation stopped) • FsX'tal=32.768kHz crystal oscillation mode • System clock set to internal RC oscillation. • 1/2 frequency division ratio	4.5 to 5.5		0.41	2.0	
	IDDHALT(9)			3.0 to 3.6		0.20	0.95	
	IDDHALT(10)			2.7 to 3.0		0.17	0.70	

Note 7-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors.

Continued from preceding page.

Parameter	Symbol	Pin/ Remarks	Conditions	Specification				
				V$_{DD}$ [V]	min	typ	max	unit
HALT mode consumption current (Note 7-1)	IDDHALT(11)	V$_{DD}$1 =V$_{DD}$2 =V$_{DD}$3	• HALT mode • FmCF=0MHz (oscillation stopped) • FsX'tal=32.768kHz crystal oscillation mode • System clock set to crystal oscillation. (32.768kHz) • Internal RC oscillation stopped • 1/2 frequency division ratio	4.5 to 5.5		31	132	mA
	IDDHALT(12)			3.0 to 3.6		9.1	39	
	IDDHALT(13)			2.7 to 3.0		6.3	27	
HOLD mode consumption current	IDDHOLD(1)	V$_{DD}$1	• HOLD mode • CF1=V$_{DD}$ or open (External clock mode)	4.5 to 5.5		0.14	39	μA
	IDDHOLD(2)			3.0 to 3.6		0.04	19	
	IDDHOLD(3)			2.7 to 3.0		0.04	17	
Timer HOLD mode consumption current	IDDHOLD(4)		• Timer HOLD mode • CF1=V$_{DD}$ or open (External clock mode) • FsX'tal=32.768kHz crystal oscillation mode	4.5 to 5.5		25	115	
	IDDHOLD(5)			3.0 to 3.6		6.0	32	
	IDDHOLD(6)			2.7 to 3.0		3.7	20	

Note 7-1: The consumption current value includes none of the currents that flow into the output Tr and internal pull-up resistors

USB Characteristics and Timing at Ta = −40°C to +85°C, V$_{SS}$1 = V$_{SS}$2 = V$_{SS}$3 = 0V

Parameter	Symbol	Conditions	Specification			
			min	typ	max	unit
High level output	V$_{OH(USB)}$	• 15kΩ ± 5% to GND	2.8		3.6	V
Low level output	V$_{OL(USB)}$	• 1.5kΩ ± 5% to 3.6V	0.0		0.3	V
Output signal crossover voltage	V$_{CRS}$		1.3		2.0	V
Differential input sensitivity	V$_{DI}$	• $\mid$(UHD+)-(UHD-)$\mid$	0.2			V
Differential input common mode range	V$_{CM}$		0.8		2.5	V
High level input	V$_{IH(USB)}$		2.0			V
Low level input	V$_{IL(USB)}$				0.8	V
USB data rise time	t$_R$	• R$_S$=33Ω, C$_L$=50pF	4		20	ns
USB data fall time	t$_F$	• R$_S$=33Ω, C$_L$=50pF	4		20	ns

F-ROM Programming Characteristics at Ta = +10°C to +55°C, V$_{SS}$1 = 0V

Parameter	Symbol	Pin/ Remarks	Conditions	Specification				
				V$_{DD}$ [V]	min	typ	max	unit
Onboard programming current	IDDFW(1)	V$_{DD}$1	• Excluding power dissipation in the microcontroller block	3.0 to 5.5		5	10	mA
Programming time	tFW(1)		• Erase operation	3.0 to 5.5		20	30	ms
	tFW(2)		• Write operation			40	60	μs

Characteristics of a Sample Main System Clock Oscillation Circuit

Given below are the characteristics of a sample main system clock oscillation circuit that are measured using an our company-designated oscillation characteristics evaluation board and external components with circuit constant values with which the oscillator vendor confirmed normal and stable oscillation.
Table 1 shows the characteristics of a oscillation circuit when USB host function is not used.
If USB host function is to be used, it is absolutely recommended to use an oscillator that satisfies the precision and stability according to the USB standards.

Table 1 Characteristics of a Sample Main System Clock Oscillator Circuit with a Ceramic Oscillator

Nominal Frequency	Vendor Name	Oscillator Name	Circuit Constant			Operating Voltage Range [V]	Oscillation Stabilization Time		Remarks
			C1 [pF]	C2 [pF]	Rd1 [Ω]		typ [ms]	max [ms]	
6MHz	MURATA	CSTCR6M00GH5L**-R0	(39)	(39)	1k	2.7 to 5.5	0.1	0.5	
8MHz	MURATA	CSTCE8M00GH5L**-R0	(33)	(33)	470	3.0 to 5.5	0.1	0.5	C1 and C2
10MHz	MURATA	CSTCE10M0GH5L**-R0	(33)	(33)	330	3.0 to 5.5	0.1	0.5	integrated
12MHz	MURATA	CSTCE12M0GH5L**-R0	(33)	(33)	330	3.0 to 5.5	0.1	0.5	SMD type

The oscillation stabilization time refers to the time interval that is required for the oscillation to get stabilized in the following cases (see Figure 4):
  • Till the oscillation gets stabilized after V_{DD} goes above the operating voltage lower limit.
  • Till the oscillation gets stabilized after the instruction for starting the main clock oscillation circuit is executed
  • Till the oscillation gets stabilized after the HOLD mode is reset.
  • Till the oscillation gets stabilized after the X'tal HOLD mode is reset with CFSTOP (OCR register, bit 0) set to 0

Characteristics of a Sample Subsystem Clock Oscillator Circuit

Given below are the characteristics of a sample subsystem clock oscillation circuit that are measured using an our company-designated oscillation characteristics evaluation board and external components with circuit constant values with which the oscillator vendor confirmed normal and stable oscillation.

Table 2 Characteristics of a Sample Subsystem Clock Oscillator Circuit with a Crystal Oscillator

Nominal Frequency	Vendor Name	Oscillator Name	Circuit Constant				Operating Voltage Range [V]	Oscillation Stabilization Time		Remarks
			C3 [pF]	C4 [pF]	Rf [Ω]	Rd2 [Ω]		typ [s]	max [s]	
32.768kHz	EPSON TOYOCOM	MC-306	18	18	OPEN	560k	2.7 to 5.5	1.1	3.0	Applicable CL value=12.5pF SMD type

The oscillation stabilization time refers to the time interval that is required for the oscillation to get stabilized in the following cases (see Figure 4):
  • Till the oscillation gets stabilized after the instruction for starting the subclock oscillation circuit is executed
  • Till the oscillation gets stabilized after the HOLD mode is reset with EXTOSC (OCR register, bit 6) set to 1

Note: The components that are involved in oscillation should be placed as close to the IC and to one another as possible because they are vulnerable to the influences of the circuit pattern.
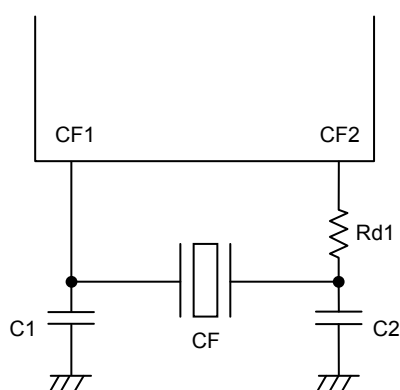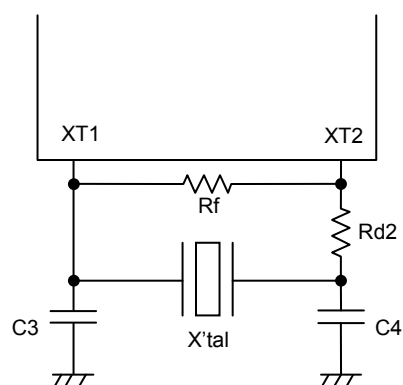

Figure 1. CF Oscillator Circuit

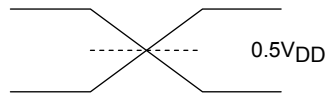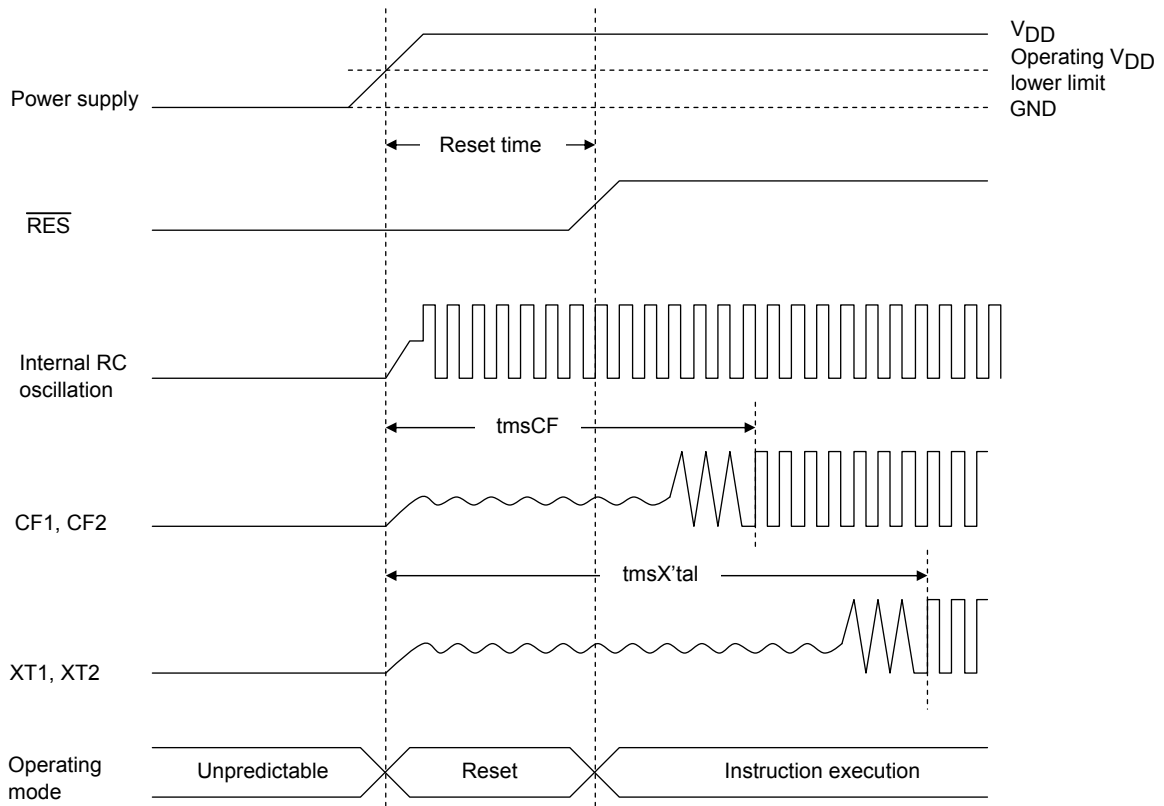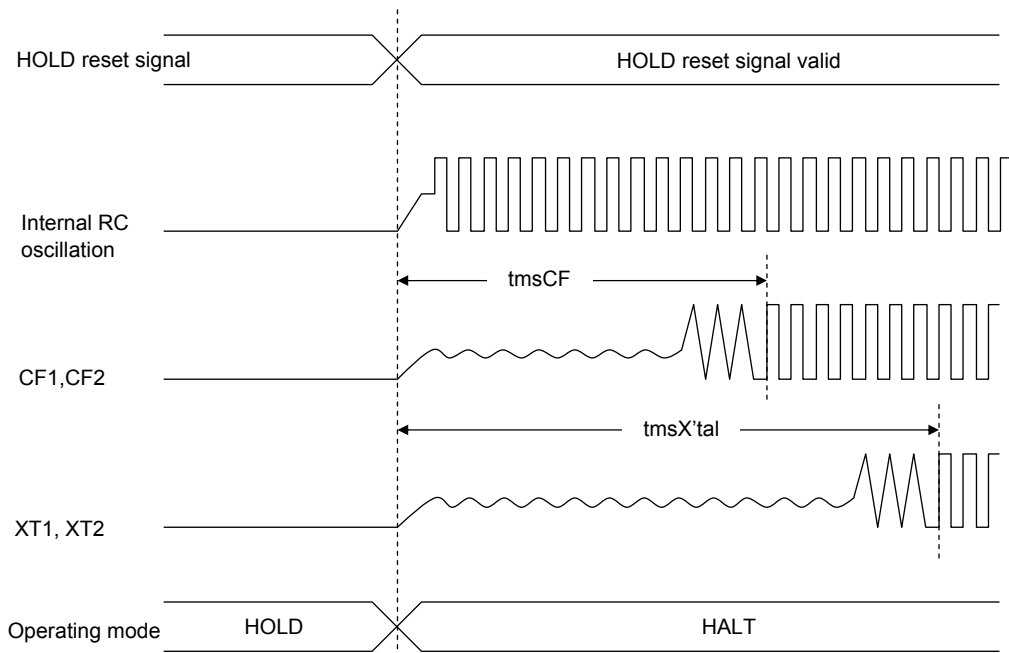Figure 2. Crystal Oscillator Circuit

Figure 3. AC Timing Measurement Point

Reset Time and Oscillation Stabilization Time

HOLD Reset Signal and Oscillation Stabilization Time

Figure 4. Oscillation Stabilization Time